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Electronic supplementary information (ESI)

Regeneration of Glass Nanofluidic Chips through a Multiple-Step Sequential Thermochemical Decomposition Process at High Temperatures

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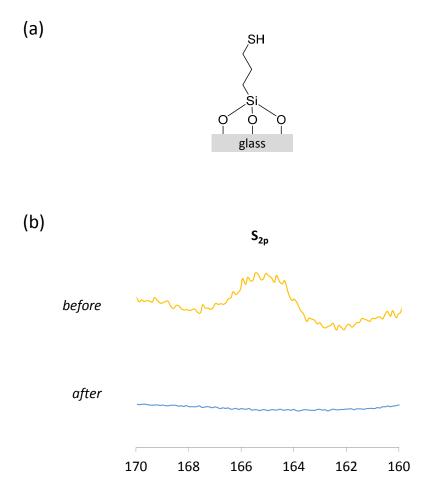
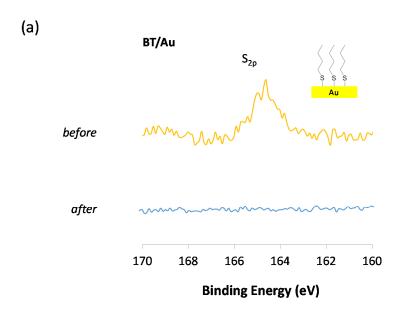


Fig. S1 XPS spectra of sulfur (S_{2p}) on (a) 3-mercaptopropyltrimethoxysilane (MPTS) modified glass substrates (b) before and after treated by the regeneration process. The MPTS modified glass substrates were prepared using an absolute ethanol solution of MPTS (2.5 wt%) according to a silanization process reported by C. R. Vistas et al. (*Appl. Surf. Sci.*, 2013, **286**, 314–318).

Binding Energy (eV)



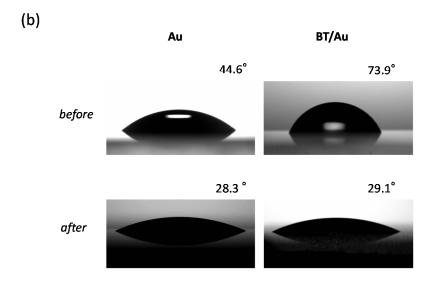


Fig. S2 (a) XPS spectra of sulfur (S_{2p}) and (b) water contact angle measurements on the gold-deposited glass substrates with hydrophobic 1-butanethiol (BT) SAMs before and after treated by the regeneration process.



Fig. S3 A bright-field image of the gold nanoarrays after the second-time regeneration.